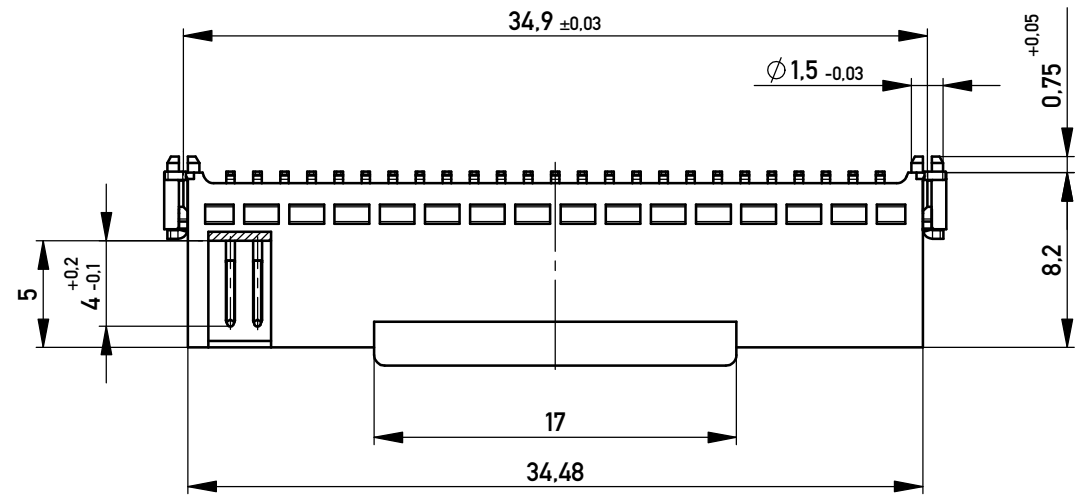
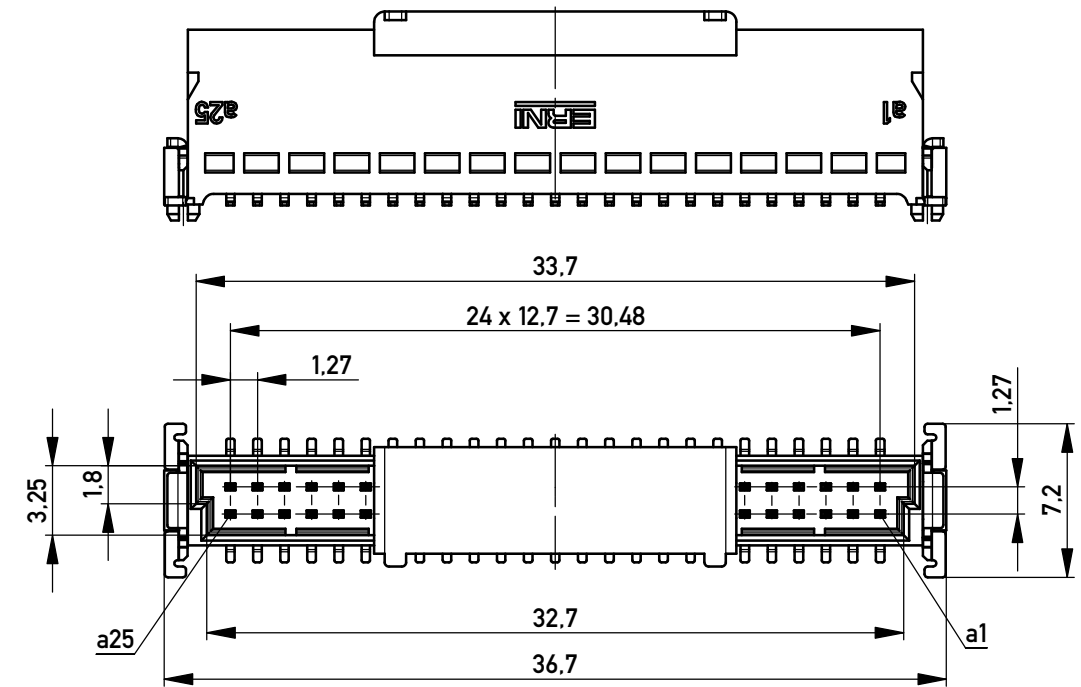
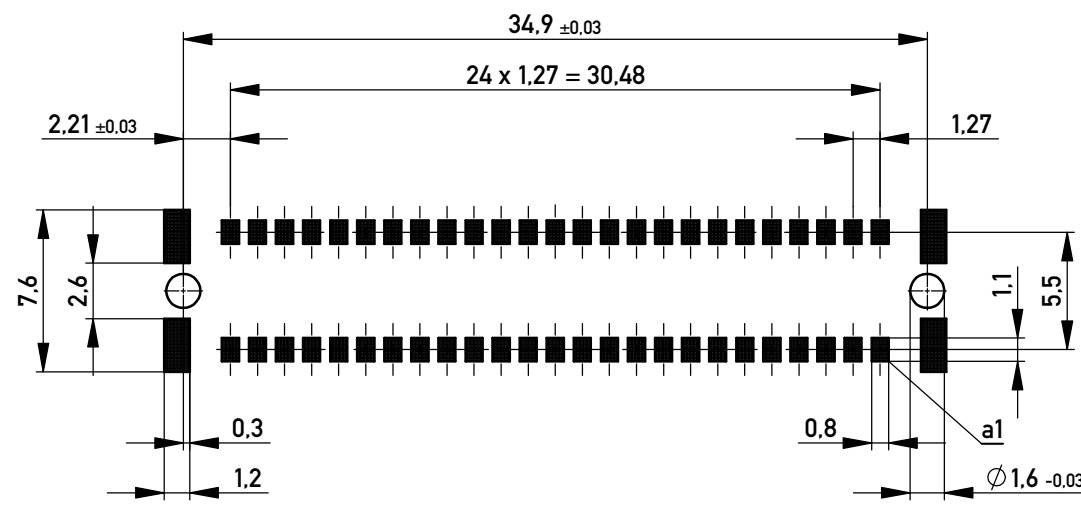
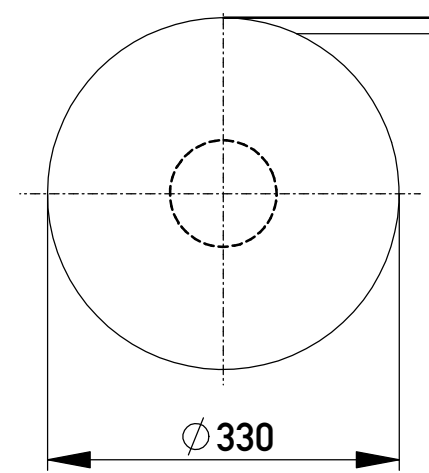


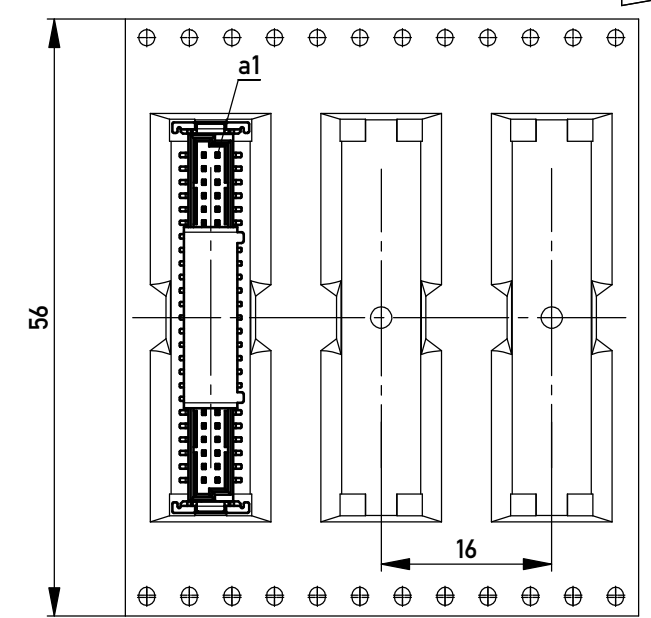
Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT



Verpackt im Gurt nach DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 280 Stück
Packaging unit: 280 pcs



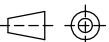
Abspulrichtung - Reel off Direction



Anforderungsstufe 1
Performance Level 1
Kontaktbereich vergoldet
Mating Area gold plating
Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating
Koplanarität der Anschlüsse ≤ 0,1 mm
Coplanarity Area of Termination ≤ 0,1 mm

BA 3-03 - Standard Bauhöhe
type 3-03 - Standard Assembly Height

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Information:				Tolerances		 All Dimensions in mm		Scale 3:1	
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Index		Date				Class		SMCQ	
								A3	

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